

**PATENT****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE****In re Application of:**

Trivedi et al.

**Serial No.: 10/000,479****Filed: October 24, 2001****For: LOCAL INTERCONNECT  
STRUCTURE FOR INTEGRATED  
CIRCUIT DEVICES, SOURCE  
STRUCTURE FOR THE SAME, AND  
METHOD FOR FABRICATING THE  
SAME****Confirmation No.: 4131****Examiner: H. Vu****Group Art Unit: 2811****Attorney Docket No.: 2269-3439.4US  
(97-936.3)****CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

2/3/03

Date

Signature

Joseph A. Walkowki  
Name (Type/Print)**RESPONSE TO OFFICE ACTION****Box Non Fee Amendment  
Commissioner for Patents  
Washington, D.C. 20231****Sir:**

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed November 5, 2002, the three-month shortened statutory period for response to which expires on February 5, 2002.

**FAX RECEIVED****OCT 01 2003****PETITIONS OFFICE****RECEIVED****OCT 03 2003****OFFICE OF PETITIONS**